

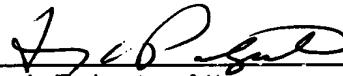
IN THE DRAWINGS

Please make the changes marked in red for Fig. 1, 2, 3A, 3B and 4 shown on the attached sheets of drawings.

REMARKS

The attached copies of the original drawings have changes marked in red thereon. To meet the drafting requirements for drawings, Fig 1, 3A and 3B are provided on multiple sheets of paper and the specification amended accordingly. A marked-up version of the amendments to paragraph [0012] of the specification is on a page attached hereto. Also enclosed are copies of the corrected formal drawings now comprising Fig. 1a, 1b, 2, 3Aa, 3Ab, 3Ba, 3Bb, 3bc, and 4. No new matter has been added.

Respectfully submitted,



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Enclosures: Post Card Receipt

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Asst. Commissioner for Patents, Washington, DC 20231 on January 22, 2002.



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MARKED-UP VERSION OF AMENDED PARAGRAPH [0012]

[0012] A more complete understanding of the present invention will become apparent from the following description taken in conjunction with the accompanying drawings, wherein:

Fig. 1 comprising Fig. 1a and Fig. 1b illustrates a modular architecture in accordance with an aspect of the present invention;

Fig. 2 illustrates a block diagram of the ELMC communication with the vehicle in accordance with an aspect of the present invention;

Fig. 3A comprising Fig. 3Aa and 3Ab illustrates a block diagram of a Load Management Module in accordance with an aspect of the present invention;

Fig. 3B comprising Fig. 3Ba, 3Bb and 3Bc illustrates a block diagram of logic in an application specific integrated circuit in accordance with an aspect of the present invention; and

Fig. 4 illustrates packaging of the ELMC in accordance with an aspect of the present invention.

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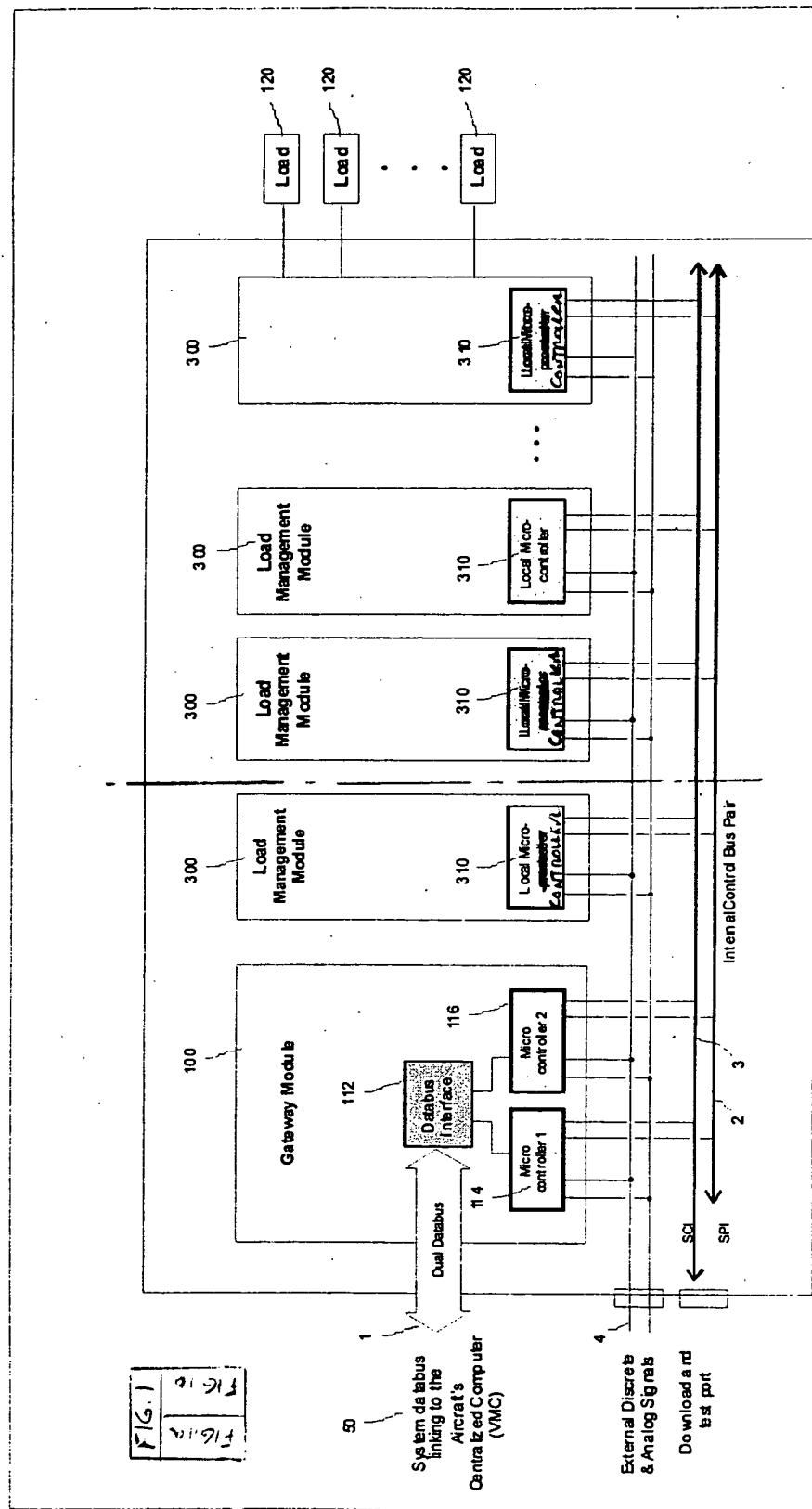


FIG. 1a
FIG. 1b
Fig. 1-ELMG Modular Architecture

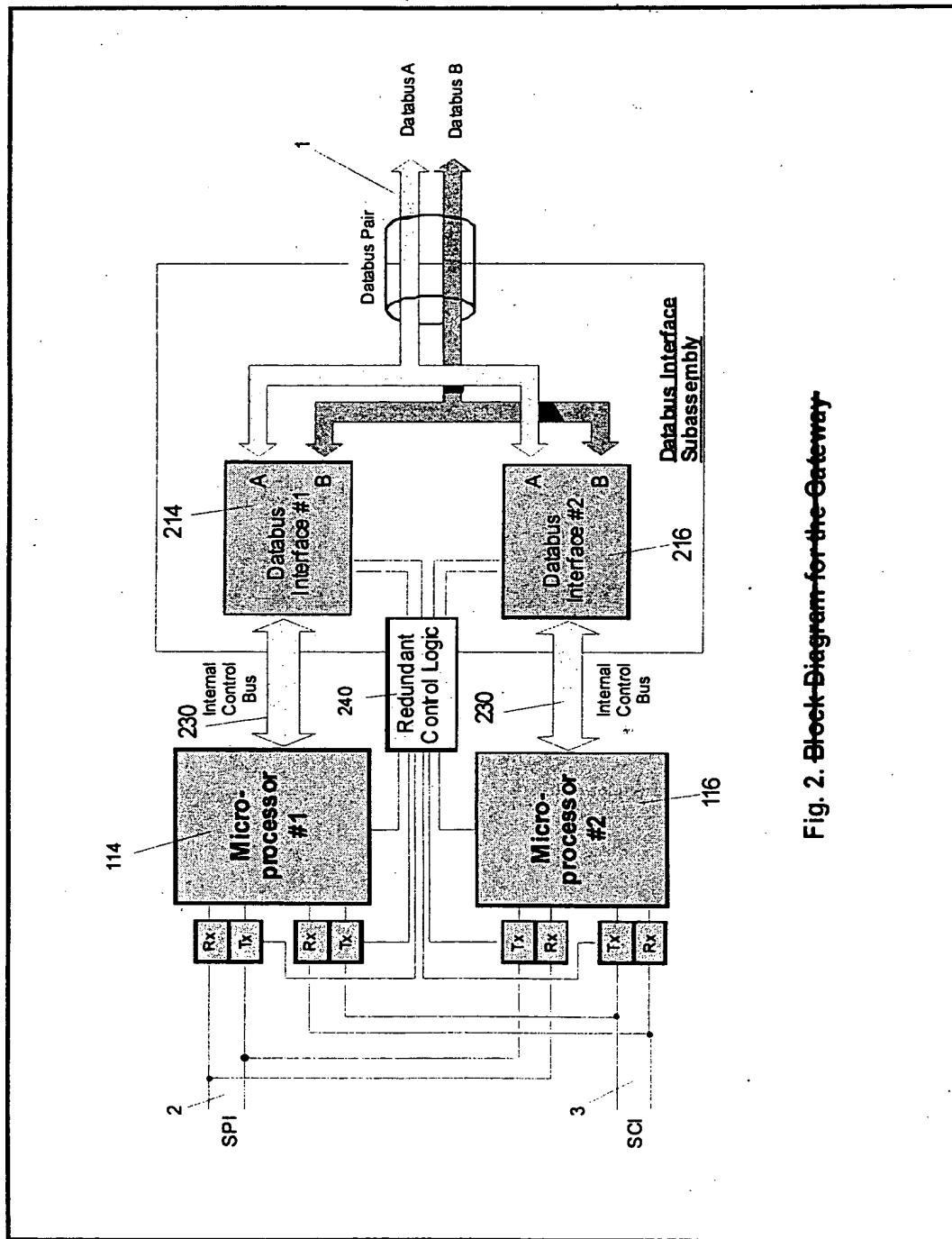


Fig. 2. Block Diagram for the Gateway

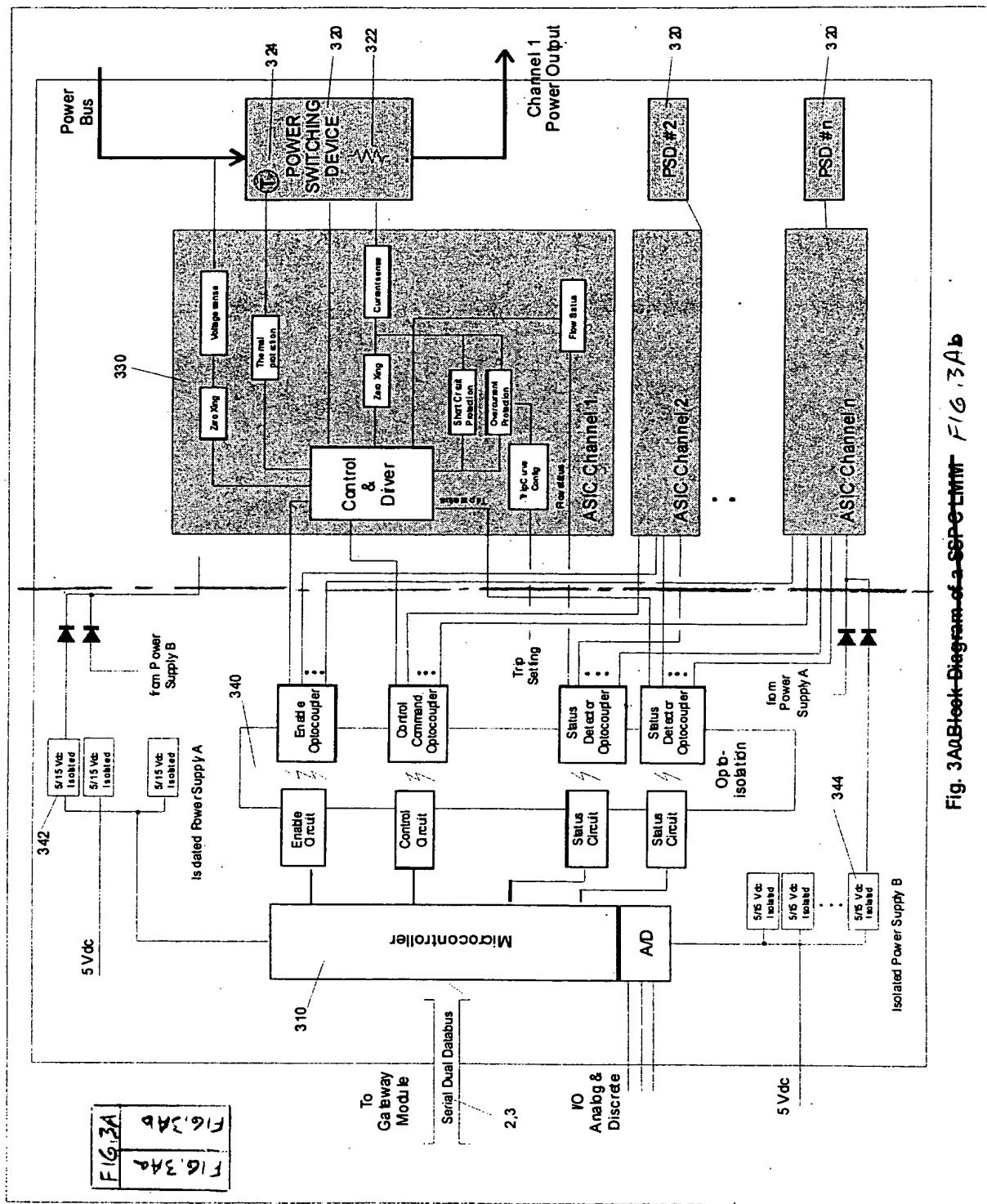


Fig. 3 AuBleek-Diagramm of a specimen FIG. 3 Ab

Fig. 3B

Fig. 3B-Aasic Functional Diagram

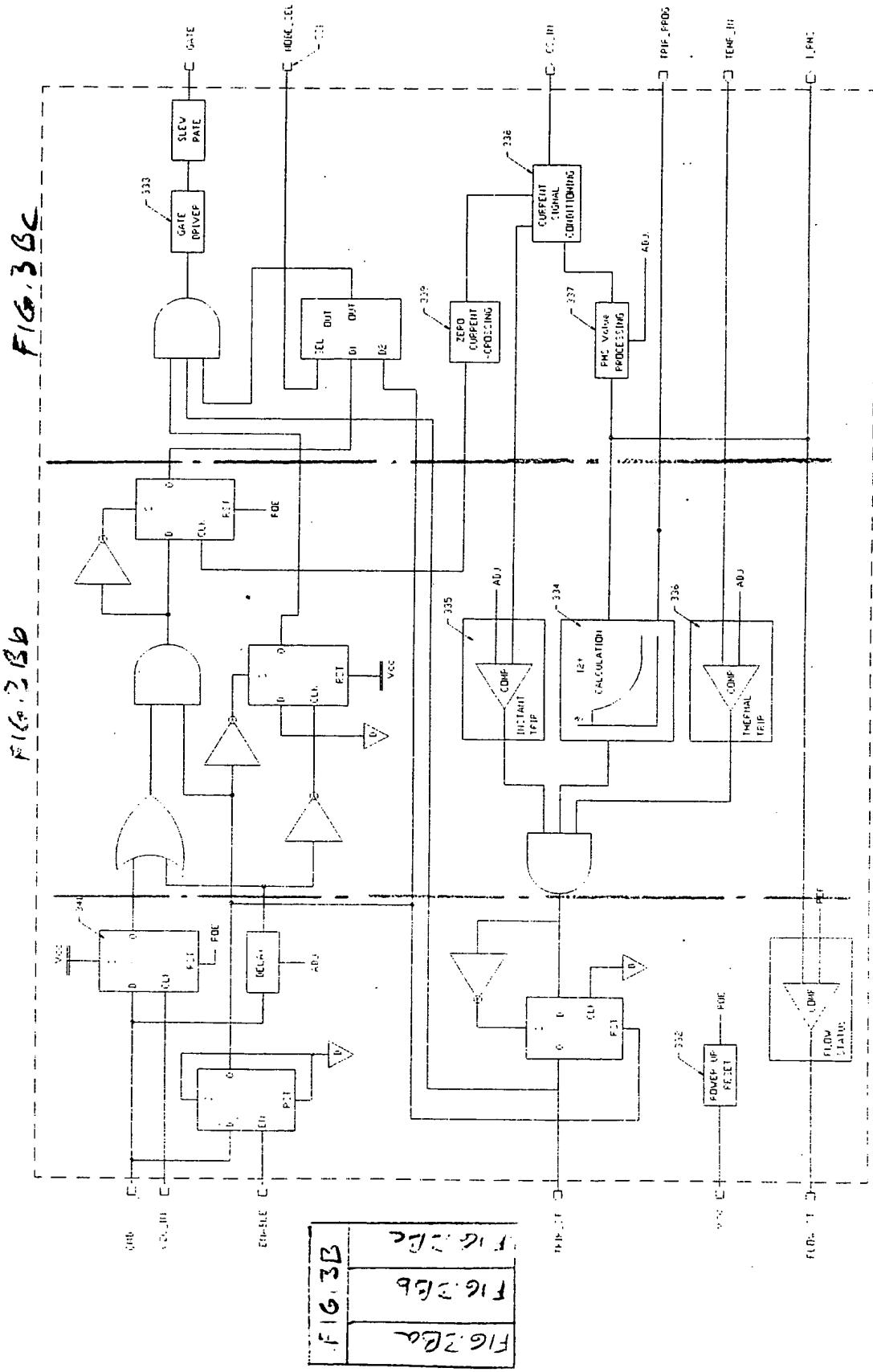


Figure 4. Mechanical Machine Model

